

Product Compliance Declaration

Please see www.molex.com for the most up-to-date information.

Contact Information

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Part Information

Part Number 0346910082 Part Weight 5.172G

Part Name STAC64 RA HDR 8 CKT BRN POL C TRAY

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
STAC64 RA HDR 8 CKT BRN POL C TRAY	Assembly		100	5.172
STAC64 RA HDR HOUSING 8 CKT BRN POL C	Component		81.5545	4.218
PS-ST GF BROWN	Material		81.5545	4.218
PS-ST	Substance		47.7525	2.469757
GF-Fibre	Substance		24.4664	1.2654
Further Additives, not to declare	Substance	system	2.745	0.141974
Boric acid	Substance	10043-35-3	0.1001	0.00518
Pigment portion, not to declare	Substance	system	0.9727	0.050308
Benzene, ethenyl-, polymer with 1,3-butadiene, hydrogenated	Substance	66070-58-4	5.5178	0.285381
0.64 X 34.93 SQ PIN BRASS REFLOW SN	Component		9.6674	0.5
SQ WIRE C26000 PL 0.625 X 0.625	Material		9.6674	0.5
Cartridge Brass 70% Unplated	Material		9.4689	0.48973
Copper	Substance	7440-50-8	6.6282	0.342811

Form Rev - F

Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)	
Zinc (metal)	Substance	7440-66-6 2.8407		0.146919	
Copper Plating	Material		0.019	0.000981	
Copper	Substance	7440-50-8	0.019	0.000981	
Tin Plating	Material		0.1037	0.005365	
Tin	Substance	7440-31-5	0.1037	0.005365	
Nickel Plating	Material		0.0759	0.003925	
Nickel	Substance	7440-02-0	0.0759	0.003924	
Further Additives, not to declare	Substance	system	8E-06	4E-07	
0.64 X 29.86 SQ PIN BRASS REFLOW SN	Component		7.6566	0.396	
SQ WIRE C26000 PL 0.625 X 0.625	Material		7.6566	0.396	
Cartridge Brass 70% Unplated	Material		7.4993	0.387866	
Copper	Substance	7440-50-8	5.2495	0.271506	
Zinc (metal)	Substance	7440-66-6	2.2498	0.11636	
Copper Plating	Material		0.015		
Copper	Substance	7440-50-8	7440-50-8 0.015		
Tin Plating	Material		0.0821	0.004249	
Tin	Substance	7440-31-5	0.0821	0.004249	
Nickel Plating	Material		0.0601	0.003108	
Nickel	Substance	7440-02-0	0.0601	0.003108	
Further Additives, not to declare	Substance	system	system 6E-06		
PIN ALIGNMENT PLATE-8CKT STAC64	Component		1.1214		
ST MYLAR 0.25 X 16.70 PET NATURAL	Material	1.1214		0.058	
PET	Material		1.1214	0.058	
Polyethylene terephthalate	Substance	25038-59-9	1.0911	0.056434	
Further Additives, not to declare	Substance	system	0.0303	0.001566	

ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2020)9139-DC (19 Jan 2021)

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
L Boric acid	STAC64 RA HDR HOUSING 8 CKT BRN POL C	1,000	1,228	Yes

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
lead	Cartridge Brass 70% (CA260)	*Note	350	Yes
Boric acid	PS-ST GF BROWN	*Note	1,228	Yes
nickel powder [particle diameter < 1 mm]	Ep-Ni	*Note	997,500	Yes
copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes
glass, oxide, chemicals	PS-ST GF BROWN	*Note	300,000	Yes
lead	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	150	Yes
copper	e-plate Cu (electrodeposited Copper Coatings)	*Note	999,625	Yes

^{*}Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

Exemptions

Part Name	Exemption
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/cm2/week)
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

None

China ROHS Declaration Information

Part Number 0346910082

Part Name STAC64 RA HDR 8 CKT BRN POL C

TRAY





Hazardous Substances

Components	Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
STAC64 RA HDR 8 CKT BRN POL C TRAY	0	0	0	0	0	0
STAC64 RA HDR HOUSING 8 CKT BRN POL C	0	0	0	0	0	0
0.64 X 34.93 SQ PIN BRASS REFLOW SN	0	0	0	0	0	0
0.64 X 29.86 SQ PIN BRASS REFLOW SN	0	0	0	0	0	0
PIN ALIGNMENT PLATE-8CKT STAC64	0	0	0	0	0	0

Process Information

Component Plating / Surface Finish	MSn-RNi
Termination Base Alloy	Brass
Solder Alloy	N/A
Process Capability	WAVE
Maximum Exposure Time (seconds)	040
Maximum Process Temperature (C)	260
Maximum Cycles at Reflow Temperature	003
J-STD-020 Moisture Sensitivity Level	N/A

Mar 24, 2021